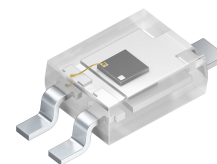


Silicon NPN Phototransistor with V_{λ} Characteristics

Version 1.3

SFH 3410



Features:

- **Spectral range of sensitivity:** (typ) 350 ... 970 nm
- **Package:** Smart DIL
- Especially suitable for applications from 350 nm to 970 nm
- Adapted to human eye sensitivity (V_{λ})
- SMT package without base connection, suitable for IR reflow soldering
- Only available on tape and reel
- The product qualification test plan is based on the guidelines of AEC-Q101-REV-C, Stress Test Qualification for Automotive Grade Discrete Semiconductors.

Applications

- For control and drive circuits
- Exposure meter for daylight and artificial light
- Sensor for backlight-dimming
- Ambient light detector

Ordering Information

Type:	Photocurrent I_{PCE} [μ A] $E_v = 20$ lx, Std. Light A, $V_{CE} = 5$ V	Ordering Code
SFH 3410	3.2 ... 25	Q65110A1211
SFH 3410-1/2	3.2 ... 10	Q65110A2653
SFH 3410-2/3	5 ... 16	Q65110A2654
SFH 3410-3/4	8 ... 25	Q65110A2655

Maximum Ratings ($T_A = 25\text{ °C}$)

Parameter	Symbol	Values	Unit
Operating and storage temperature range	$T_{op}; T_{stg}$	-40 ... 100	°C
Collector-emitter voltage	V_{CE}	5.5	V
Collector current	I_C	20	mA
Emitter-collector voltage	V_{EC}	0.5	V
ESD withstand voltage (acc. to ANSI/ ESDA/ JEDEC JS-001 - HBM)	V_{ESD}	2000	V

Characteristics ($T_A = 25\text{ °C}$)

Parameter		Symbol	Values	Unit
Wavelength of max. sensitivity	(typ)	$\lambda_{S\ max}$	570	nm
Spectral range of sensitivity	(typ)	$\lambda_{10\%}$	(typ) 350 ... 970	nm
Radiant sensitive area	(typ)	A	0.29	mm ²
Dimensions of chip area	(typ)	L x W	(typ) 0.75 x 0.75	mm x mm
Half angle	(typ)	φ	± 60	°
Capacitance ($V_{CE} = 0\text{ V}$, $f = 1\text{ MHz}$, $E = 0$)	(typ)	C_{CE}	3.9	pF
Photocurrent ($E_v = 20\text{ lx}$, Std. Light A, $V_{CE} = 5\text{ V}$)		I_{PCE}	> 3.2	μA
Dark current ($V_{CE} = 5\text{ V}$, $E = 0$)	(typ (max))	I_{CE0}	3 (≤ 50)	nA

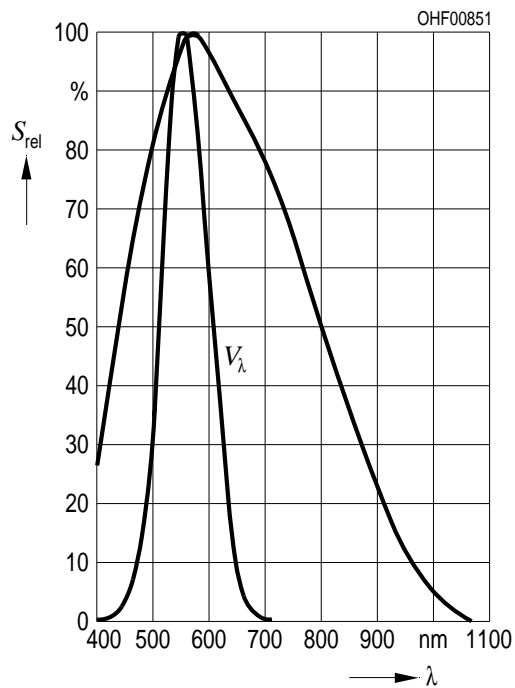
Grouping ($T_A = 25\text{ °C}$)

Group	Min Photocurrent	Max Photocurrent	Collector-emitter saturation voltage
	$E_V = 20\text{ lx, Std. Light A, } V_{CE} = 5\text{ V}$ $I_{PCE, min} [\mu\text{A}]$	$E_V = 20\text{ lx, Std. Light A, } V_{CE} = 5\text{ V}$ $I_{PCE, max} [\mu\text{A}]$	$I_C = I_{PCEmin} \times 0.3,$ $E_V = 20\text{ lx}$ $V_{CEsat} [\text{mV}]$
SFH 3410-1	3.2	6.3	100
SFH 3410-2	5	10	100
SFH 3410-3	8	16	100
SFH 3410-4	12.5	25	100

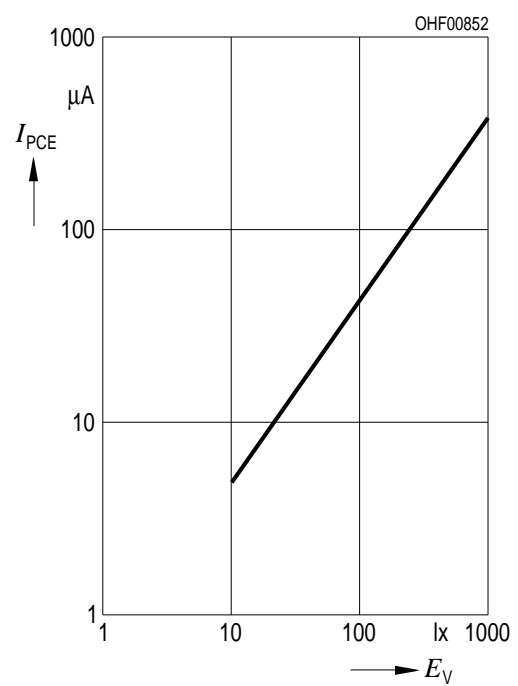
Note.: I_{PCEmin} is the min. photocurrent of the specified group

Relative Spectral Sensitivity ^{1) page 12}

$$S_{rel} = f(\lambda)$$

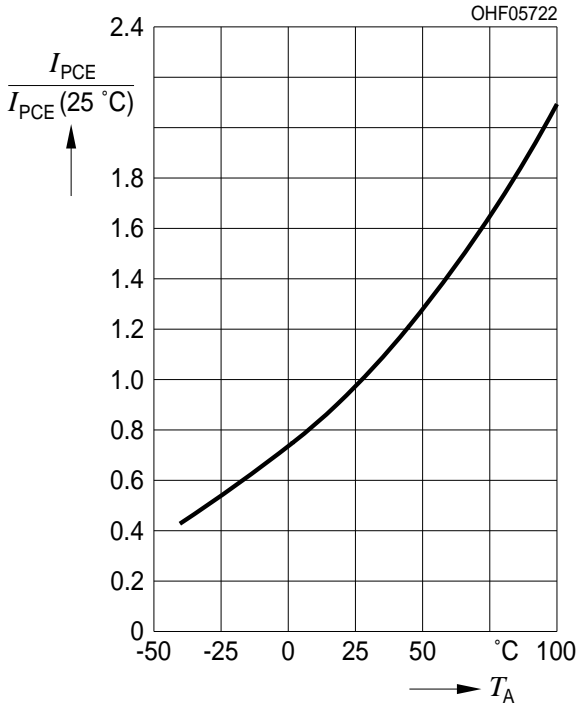
Photocurrent ^{1) page 12}

$$I_{PCE} = f(E_V), V_{CE} = 5\text{ V}$$



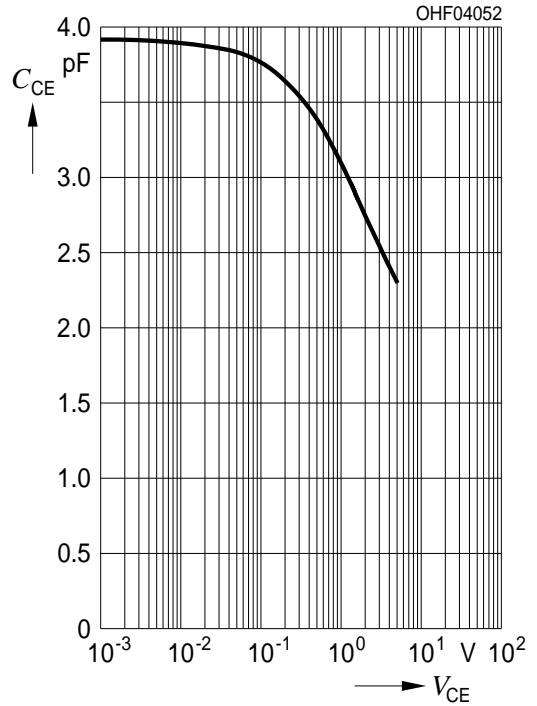
Photocurrent ^{1) page 12}

$I_{PCE} / I_{PCE}(25^\circ\text{C}) = f(T_A), E_V = 20 \text{ lx}, V_{CE} = 1 \text{ V} \dots 5 \text{ V}$



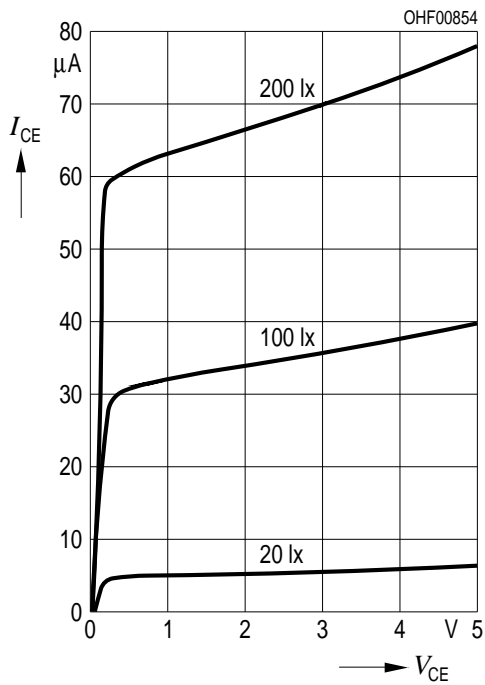
Collector-Emitter Capacitance ^{1) page 12}

$C_{CE} = f(V_{CE}), f = 1 \text{ MHz}, E = 0$



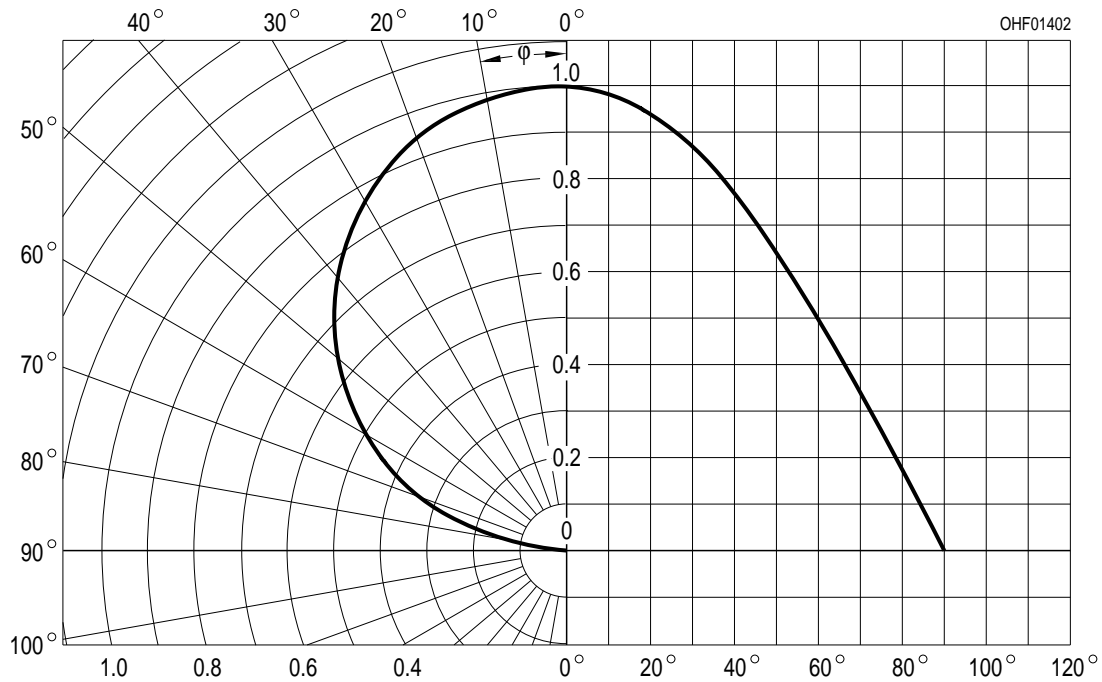
Collector-Emitter Current ^{1) page 12}

$I_{CE} = f(V_{CE}; E_V)$

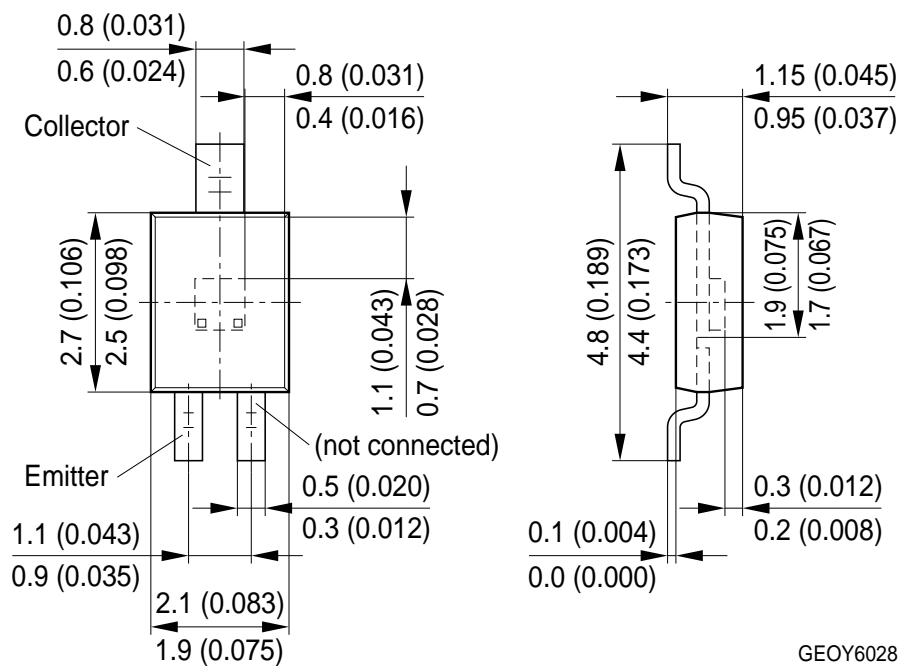


Directional Characteristics ^{1) page 12}

$S_{rel} = f(\phi)$



Package Outline

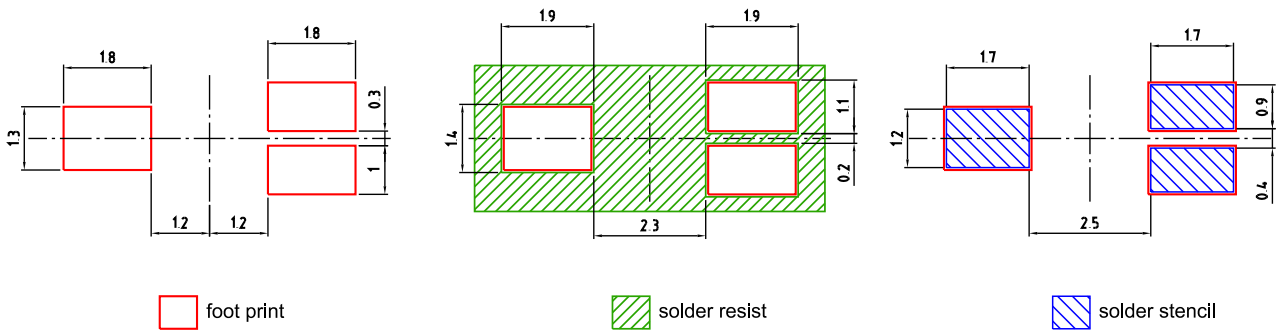


Dimensions in mm (inch).

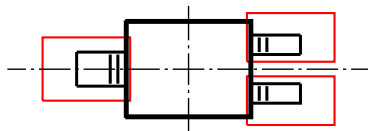
Package
Smart DIL

Approximate Weight:
12 mg

Recommended Solder Pad



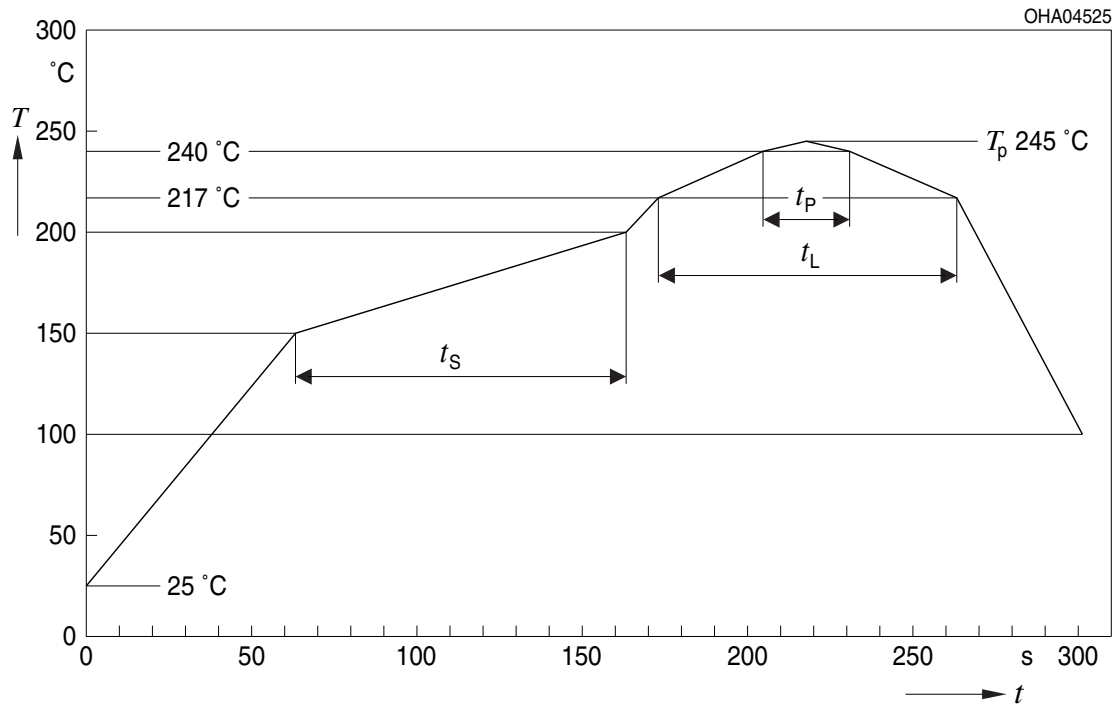
Component Location on Pad



E062.3010.216-01

Reflow Soldering Profile

Product complies to MSL Level 4 acc. to JEDEC J-STD-020D.01



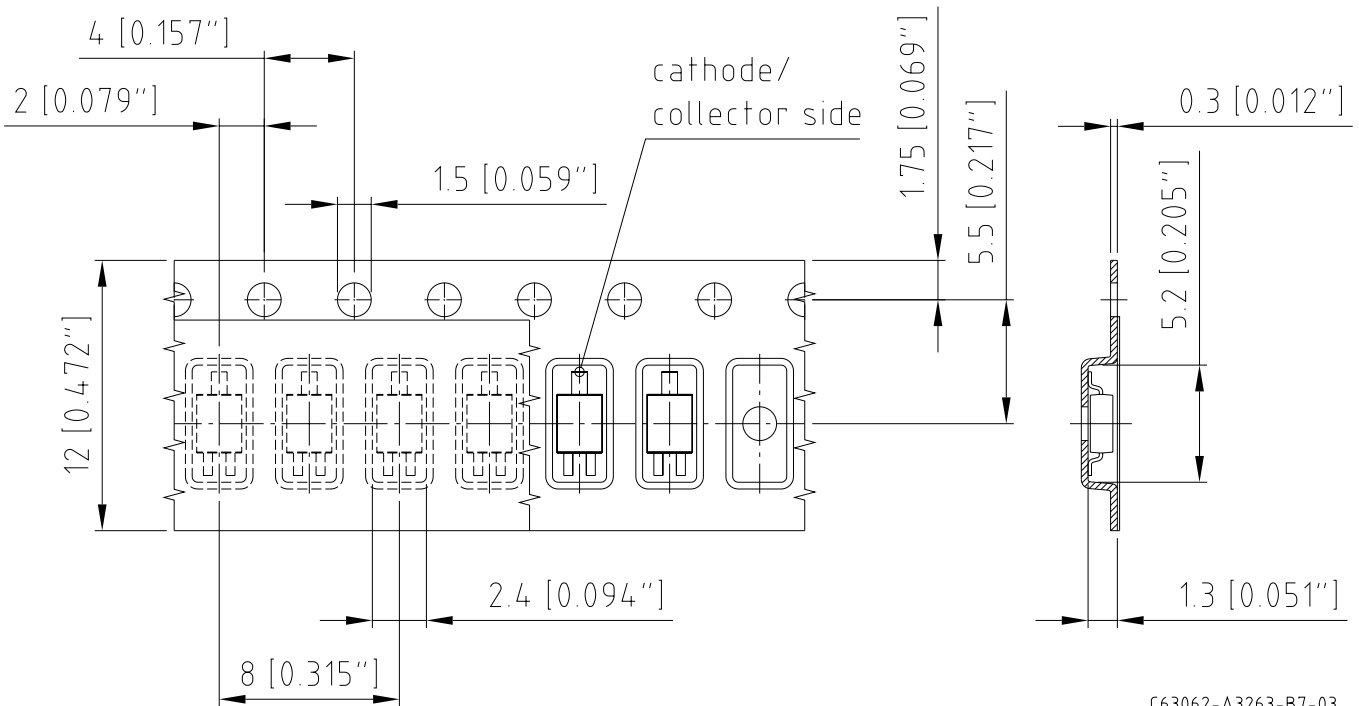
OHA04612

Profile Feature Profil-Charakteristik	Symbol Symbol	Pb-Free (SnAgCu) Assembly			Unit Einheit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t_s	60	100	120	s
Ramp-up rate to peak*) T_{Smax} to T_p			2	3	K/s
Liquidus temperature	T_L	217			°C
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_p		245	260	°C
Time within 5 °C of the specified peak temperature $T_p - 5$ K	t_p	10	20	30	s
Ramp-down rate* T_p to 100 °C			3	6	K/s
Time 25 °C to T_p				480	s

All temperatures refer to the center of the package, measured on the top of the component

* slope calculation DT/Dt : Dt max. 5 s; fulfillment for the whole T-range

Taping



Dimensions in mm (inch).

C63062-A3263-B7-03

Tape and Reel

12 mm tape with 2000 pcs. on Ø 180 mm reel



Leader: min. 400 mm *

Trailer: min. 160 mm *

*) Dimensions acc. to IEC 60286-3; EIA 481-D

OHAY0324

Tape dimensions [mm]

W	P ₀	P ₁	P ₂	D ₀	E	F
12 + 0.3 / - 0.1	4 ± 0.1	4 ± 0.1 or 8 ± 0.1	2 ± 0.05	1.5 ± 0.1	1.75 ± 0.1	5.5 ± 0.05

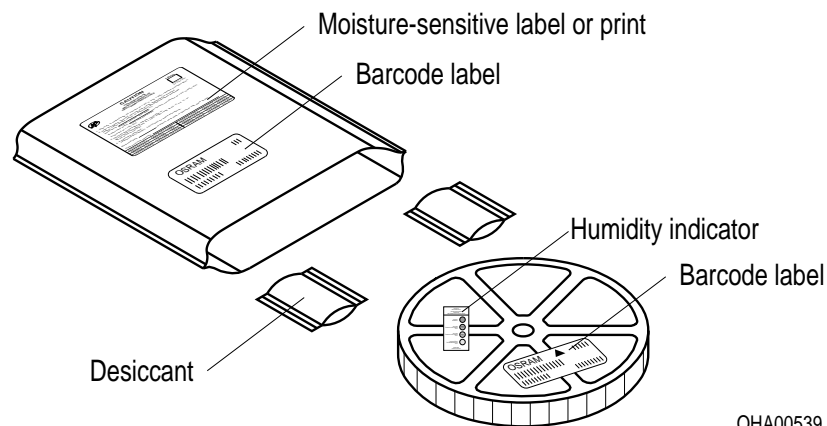
Reel dimensions [mm]

A	W	N _{min}	W ₁	W _{2max}
180	12	60	12.4 + 2	18.4

Barcode-Product-Label (BPL)



Dry Packing Process and Materials



Note:

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card. Regarding dry pack you will find further information in the internet. Here you will also find the normative references like JEDEC.

Transportation Packing and Materials



Dimensions of transportation box in mm

Width	Length	Height
195 ± 5	195 ± 5	30 ± 5

Disclaimer

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

Attention please!

The information describes the type of component and shall not be considered as assured characteristics.

Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version in the Internet.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office.

By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Components used in life-support devices or systems must be expressly authorized for such purpose!

Critical components* may only be used in life-support devices** or systems with the express written approval of OSRAM OS.

*) A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or the effectiveness of that device or system.

**) Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health and the life of the user may be endangered.

Glossary

- ¹⁾ **Typical Values:** Due to the special conditions of the manufacturing processes of LED, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

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